

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yoshiyuki MORITA</td> <td>08/03/2007</td> </tr> <tr> <td>Mitsuru OSAWA</td> <td>08/06/2007</td> </tr> <tr> <td>Ayako OMORI</td> <td>08/03/2007</td> </tr> </tbody> </table>		Name	Execution Date	Yoshiyuki MORITA	08/03/2007	Mitsuru OSAWA	08/06/2007	Ayako OMORI	08/03/2007
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Yoshiyuki MORITA	08/03/2007								
Mitsuru OSAWA	08/06/2007								
Ayako OMORI	08/03/2007								
RECEIVING PARTY DATA									
Name:	Honda R&D Co., Ltd								
Street Address:	4-1, Chuou 1-chome								
Internal Address:	Wako-Shi								
City:	Saitama								
State/Country:	JAPAN								
Postal Code:	351-0193								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11789726</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11789726				
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CORRESPONDENCE DATA									
Fax Number:	(612)349-9266								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	612-349-5740								
Email:	johnson@ptslaw.com								
Correspondent Name:	Paul B. Savereide								
Address Line 1:	80 South Eighth Street								
Address Line 2:	4800 IDS Center								
Address Line 4:	Minneapolis, MINNESOTA 55402								
ATTORNEY DOCKET NUMBER:	3486.14US01								
NAME OF SUBMITTER:	Paul B. Savereide								
Total Attachments: 2									

CH \$40.00 11789726

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ASSIGNMENT

WHEREAS, we, Yoshiyuki Morita of Saitama, Japan, Mitsuru Osawa of Saitama, Japan, and Ayako Omori of Saitama, Japan, have invented certain new and useful improvements in ANTIFREEZE/COOLANT COMPOSITION, for which an application for Letters Patent of the United States is being made, and which may be identified in the United States Patent Office by Application No. 11/789,726 filed April 24, 2007.

WHEREAS, Honda R&D Co., Ltd. ("Assignee"), a corporation organized and existing under the laws of Japan, and having its principal offices at 4-1, Chuou 1-chome, Wako-shi, Saitama 351-0193 Japan is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, our entire right, title and interest in and to said invention, said utility application, all applications claiming priority to said utility application including all divisions, continuations, or renewals thereof, and the Letters Patent, that may or shall issue, therefrom including all reissues or extensions of such patents including all of our rights under the International Convention, and we hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned Assignee in accordance herewith.

We hereby authorize the above mentioned Assignee, its successors and assigns, or anyone it may properly designate, to insert in this instrument the date of execution and/or filing date and application number of said application when ascertained.

We further authorize said Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of the International Convention.

Upon said consideration we do hereby covenant and agree with the said Assignee, its successors and assigns, that we will not execute in writing or do any act whatsoever conflicting with these presents, and that we or our executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

IN WITNESS WHEREOF, we have hereunto set my hand and affixed my seal as dated below.

Date: August. 3. 2007

Yoshiyuki Morita
Yoshiyuki Morita

Date: August. 6. 2007

Mitsuru Osawa
Mitsuru Osawa

Date: 3/8/2007

Ayako Omori
Ayako Omori